

# PATENT ASSIGNMENT

Electronic Version v1.1

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hiroshi OJI	02/10/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Rohm Co., LTD.
<b>Street Address:</b>	21 Saiin Mizosaki-cho
<b>Internal Address:</b>	Ukyo-ku
<b>City:</b>	Kyoto
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	615-8585
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	10572730
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<b>NAME OF SUBMITTER:</b>	Kelly Gastoukian
<b>Total Attachments: 1</b> source=40404-30-PTO-20100107-Signed_Assignment#page1.tif	

OP \$40.00 10572730

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**PATENT**  
**REEL: 023747 FRAME: 0143**

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

Hiroshi OJI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

ROHM CO., LTD.

21, Saiin Mizosaki-cho, Ukyo-ku

Kyoto-shi, Kyoto 615-8585

JAPAN

its successors and assigns ( hereinafter designated "ASSIGNEE" ) the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SEMICONDUCTOR DEVICE HAVING HIGH-K GATE DIELECTRIC LAYER AND METHOD FOR MANUFACTURING THE SAME

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

INVENTOR

DATE SIGNED

Hiroshi Oji  
Name: Hiroshi OJI

February 10, 2006